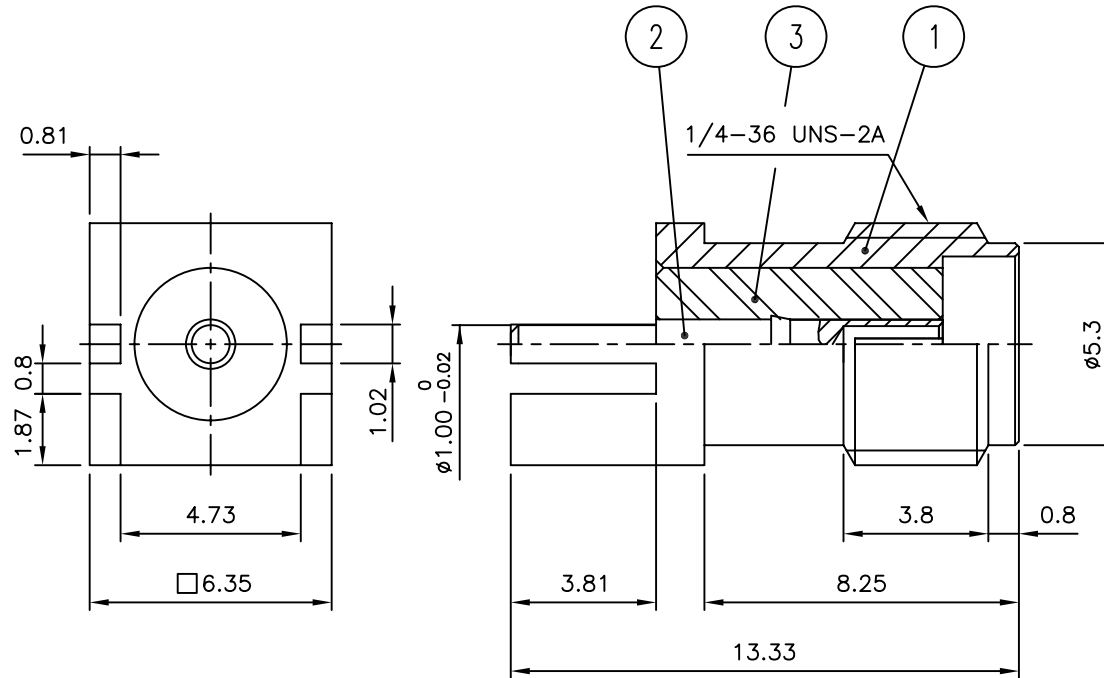


REVISION					
REV	DESCRIPTION		DRAWN	APPR	DATE
IR	Initial Registration		M.H.SONG	I.C.KIM	2014.03.05.
1	[설변처리 NO. 201411-0021] PCB납땜 조립성으로 인한 외경치수 수정		H.J.LEE	I.C.KIM	2014.11.24.



3	INSULATOR	1	TEFLON		DIN00118-N/1
2	CONTACT	1	BeCu	Gold Plate	DCT03292-5/1
1	BODY	1	MBsBD	Gold Plate	DBD02175-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2014. 11. 24.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY		KJ COMTECH CO.,LTD. TITLE SMA50 PCB SJ-4R EDGE
		DRAWN BY	H.J.LEE	
FINISH		SCALE	5/1	A4 DWG NO. CN01469-7/3 REVISION I R SHEET 1 of 1
		UNIT	mm	